

FEATURES

| Surface Mounting Design 8.3*8.3*6.0mm

High Current Handling Capability 20000A @ 8/20 μs

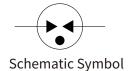
Low Capacitance and Insertion Loss

| Quick Response and Long Service Life

| Moisture sensitivity level:Level 1



8.3*8.3*6.0mm



APPLICATION INFORMATION

| Communication equipment.

Repeaters, Modems

| Telephone Interface,Line cards.

Data communication equipment.

AGENCY APPROVALS

lcon	Solderability		
RoHS	Compliance with 2011/65/EU		
HF	Compliance with IEC61249-2-21:2003		
₽b	Mean lead free		
IR.	UL Certificated E505857		

PRODUCT CHARACTERISTICS

Lead Material	Body Material	Terminal Finish
Copper or Fe-Ni alloy	i alloy Ceramics 100% Matte-Tin Plated	



ELECTRICAL PARAMETER

Parameter	Condition	Rating	Unit
DC Spark-over Voltage 1)	100V/s	280-420	
Impulse Spark-over Voltage	At 1kV/μs	for 99 % of measured values ≤900	V
impuise Spark-over voltage	At 1kV/μs	Typical values of distribution ≤850	
Discharge Current (8/20us) 2)	10 times	20	
AC Discharge Current	50Hz, 1S	20	Α
Minimum Insulation Resistance	Test Voltage DC=100V	1	GΩ
Max. Capacitance 1MHz	V _{DC} =0.5V	1.5	pF
Operating and Storage Temperature		-40~125	°C

¹⁾ In ionized mode

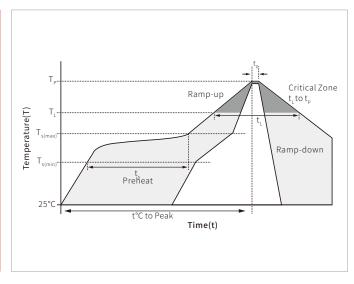
ENVIRONMENTAL RELIABILITY CHARACTERISTICS

Testing items	Technical standards		
High Temperature Storage Test	Temperature: 85°C; Time:2H		
Low Temperature Storage Test	Temperature: -40°C; Time:2H		
Vibration	Frequency: 10-500Hz ; Amplitude: 0.15mm ; Time: 45min		
Resistance of soldering heat Temperature: 260±5°C; Time of dip soldering: 10s, 1time			

NOTE:Up-screen program can be specified by customer's request via contacting Semiware service

REFLOW PROFILE

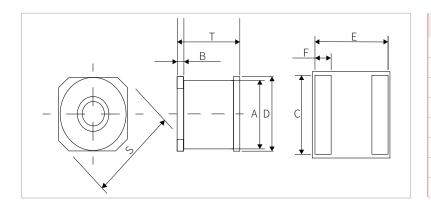
Reflow Condition		Lead-free assembly	
	Temperature Min	150°C	
Pre Heat	Temperature Max	200°C	
	Time(min to max)	60 – 180 secs	
Average ramp up rate (Liquidus) Temp (T_L) to peak T_s (max) to T_L - Ramp-up Rate		3°C/second max	
Deflam	Temperature (T _L) (Liquidus)	217°C	
Reflow	$Time(min to max)(t_s)$	60 – 150 seconds	
Peak Temperature (T _P)		260°C	
Time within 5°C of actual peak Temperature (tp)		10-30 seconds	
Ramp-down Rate		6°C/second max	
Time 25°C to peak Temperature (T₅)		8 minutes max.	
Do not exceed		260°C	



²⁾ Terms and waveforms in accordance with ITU-T Rec. K. 12; IEC 61643-21

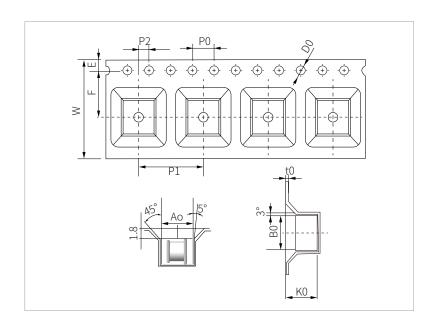


DIMENSIONS AND RECOMMENDED SOLDERING PAD



Ref.	mm	
А	8.0±0.2	
В	0.5±0.1	
С	9.0	
D	8.3±0.2	
E	6.7	
F	1.2	
Т	6.0±0.25	
S	9.0±0.4	

PACKAGE REEL INFORMATION



Ref.	mm		
W	16.0±0.3		
P0	4.0±0.1		
P1	12.0±0.1		
P2	2.0±0.1		
D0	1.55±0.05		
E	1.75±0.1		
F	7.5±0.1		
A0	6.35±0.1		
К0	6.55±0.1		
В0	8.65±0.1		
t0	0.5±0.1		

ORDERING INFORMATION

Part Number	Size	Marking	QTY/Reel	Reel Size
SG2R08B350A	8.3*8.3*6.0mm	7 SG350 <u>08</u>	600	13"



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By QR Code





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Machat

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